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(12) **United States Design Patent**
Chen et al.

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(45) **Date of Patent: ** Dec. 31, 2019**

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(54) **LIGHT EMITTING DIODE**

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(73) Assignee: **EVERLIGHT ELECTRONICS CO., LTD.**, New Taipei (TW)

(**) Term: **15 Years**

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(30) **Foreign Application Priority Data**

Jun. 17, 2016 (TW) 105303468

(51) **LOC (12) Cl.** **13-03**

(52) **U.S. Cl.**
USPC **D13/180**

(58) **Field of Classification Search**
USPC D13/180; D26/1
(Continued)

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(57) **CLAIM**

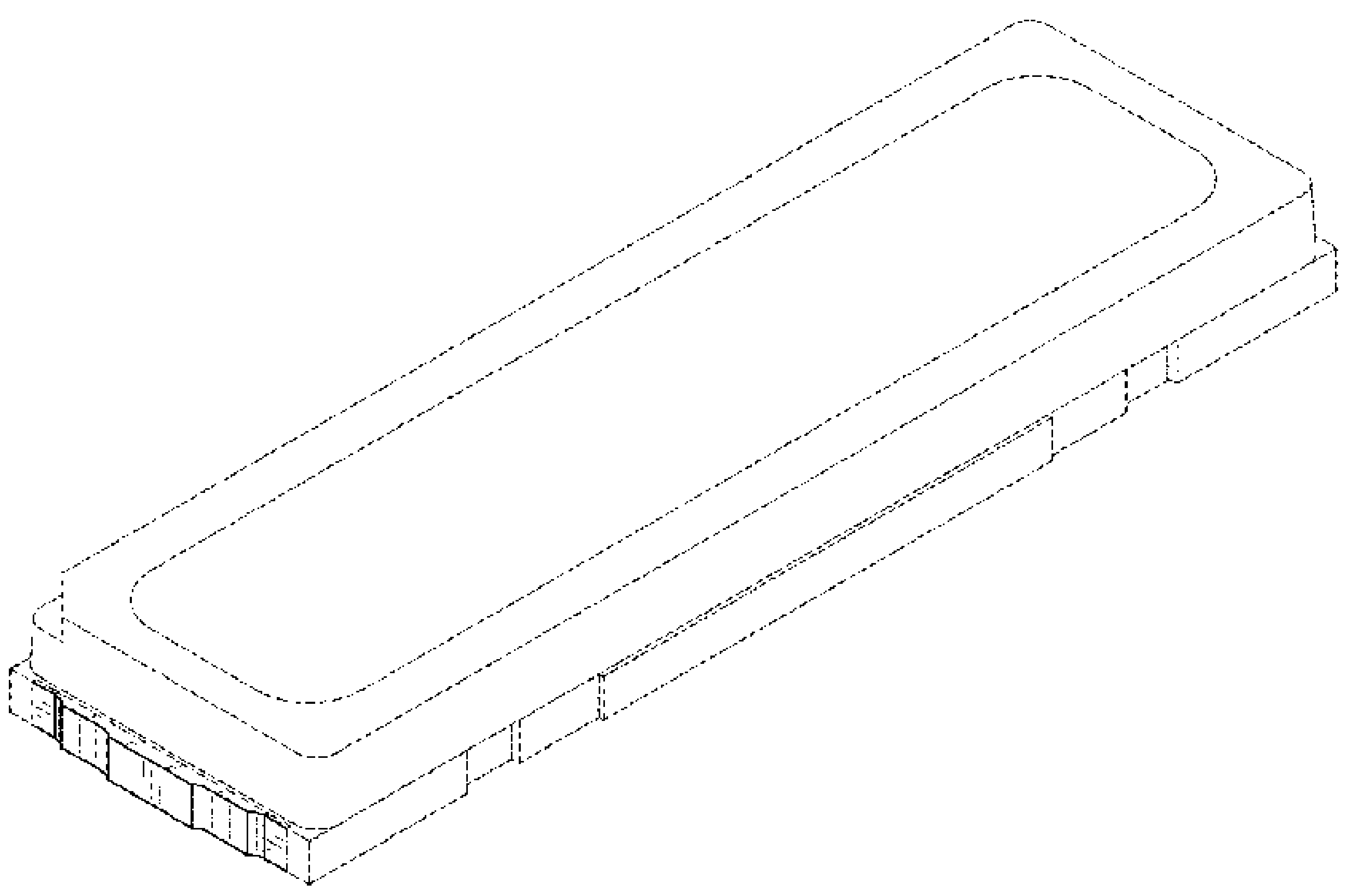
The ornamental design for a light emitting diode, as shown and described.

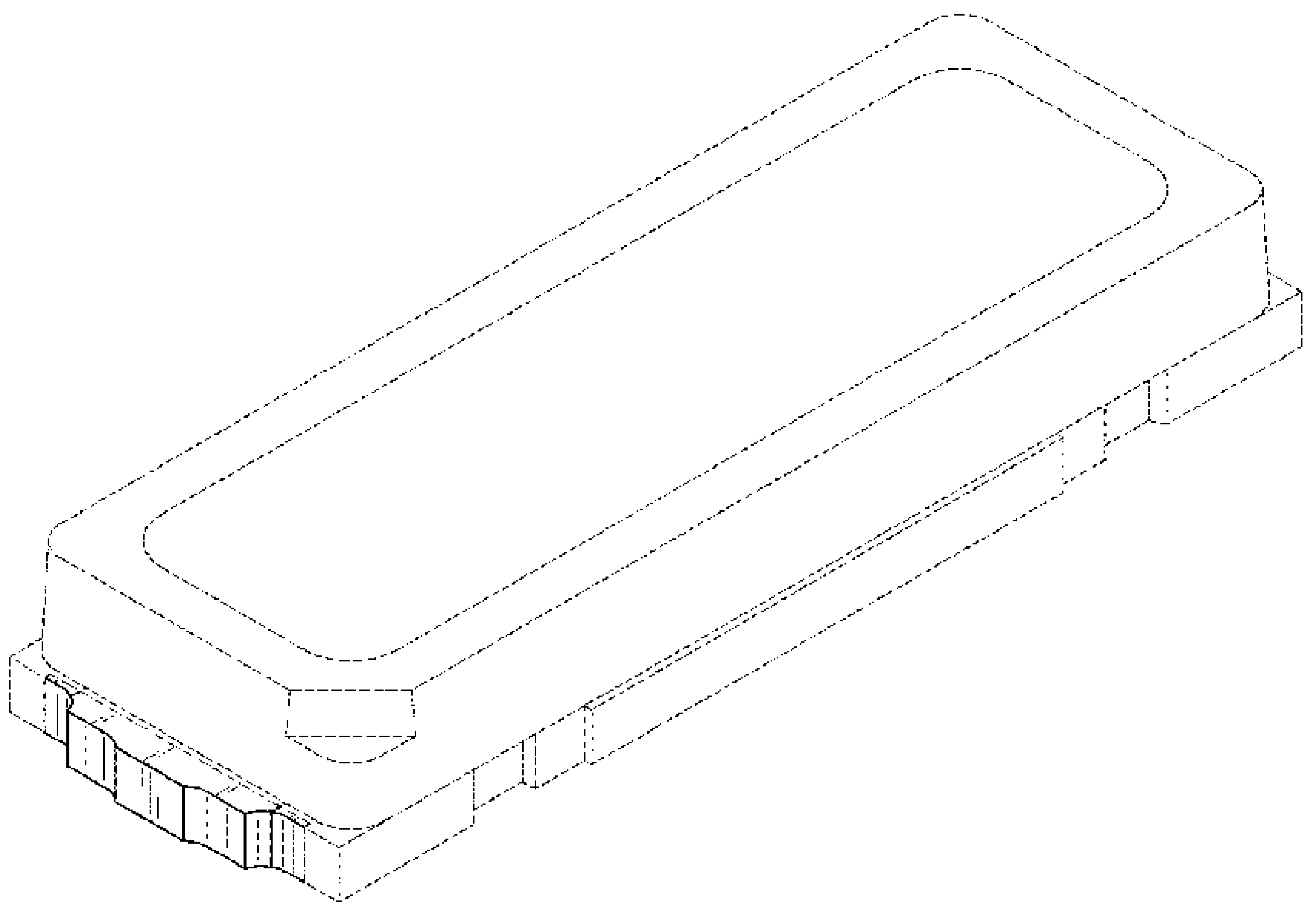
DESCRIPTION

FIG. **1** is a perspective view of a light emitting diode showing a first embodiment of our new design;
FIG. **2** is another perspective view of the first embodiment;
FIG. **3** is a front view of the first embodiment;
FIG. **4** is a rear view of the first embodiment;
FIG. **5** is a left side view of the first embodiment;
FIG. **6** is a right side view of the first embodiment;
FIG. **7** is a top view of the first embodiment;
FIG. **8** is a bottom view of the first embodiment;
FIG. **9** is a perspective view of a light emitting diode showing a second embodiment of our new design;
FIG. **10** is another perspective view of the second embodiment;
FIG. **11** is a front view of the second embodiment;
FIG. **12** is a rear view of the second embodiment;
FIG. **13** is a left side view of the second embodiment;
FIG. **14** is a right side view of the second embodiment;
FIG. **15** is a top view of the second embodiment; and,
FIG. **16** is a bottom view of the second embodiment.

The dashed line portions in the drawings form no part of the claimed design. The dot-dash lines in the drawings define the bounds of the claimed design and form no part thereof.

1 Claim, 10 Drawing Sheets





(58) **Field of Classification Search**

CPC ... H01L 25/167; H01L 25/0753; H01L 27/15; H01L 27/156; H01L 31/02; H01L 33/00; H01L 33/04; H01L 33/08; H01L 33/10; H01L 33/20; H01L 33/38; H01L 33/42; H01L 33/48; H01L 33/483; H01L 33/486

See application file for complete search history.

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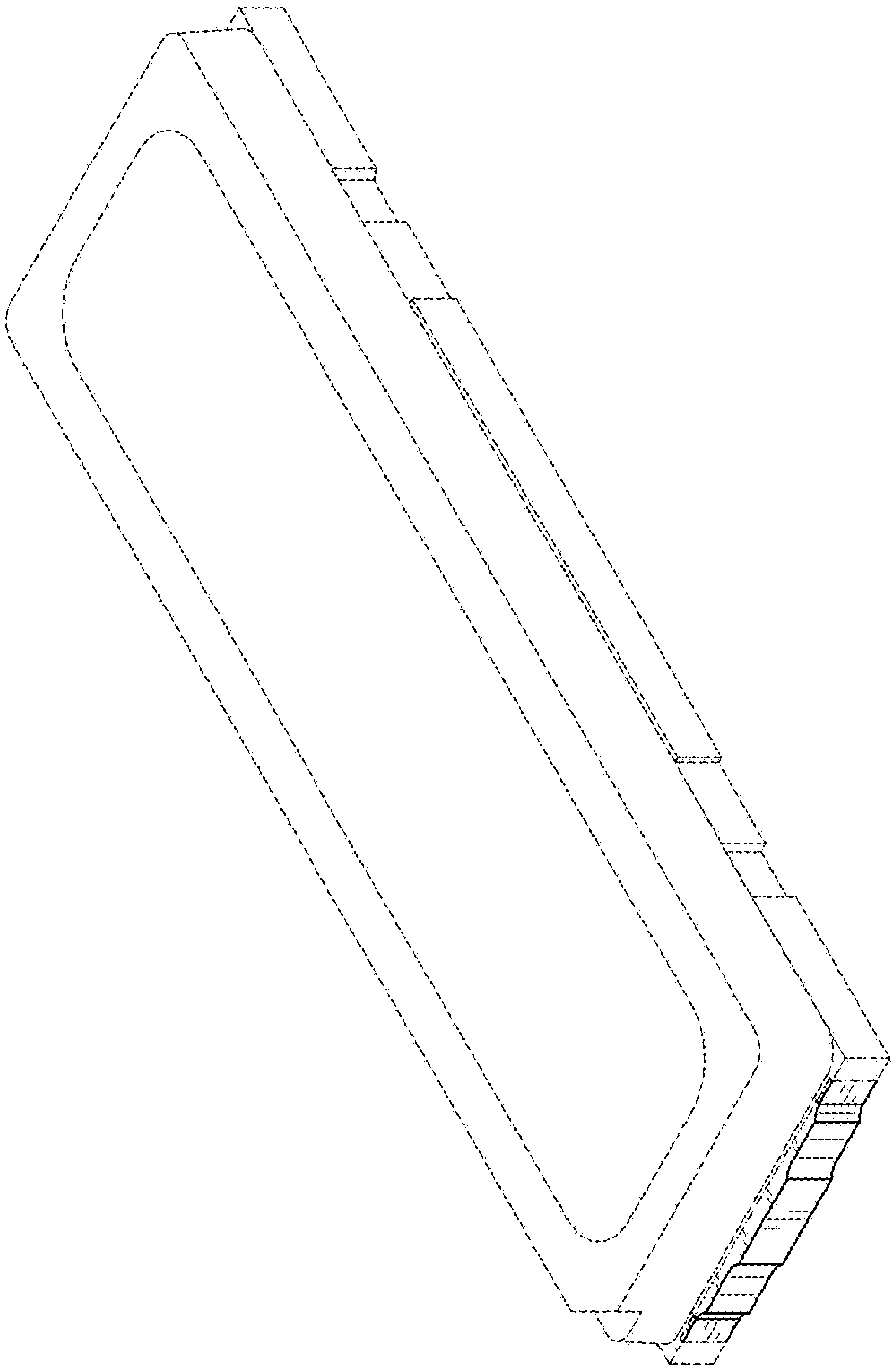

FIG. 1

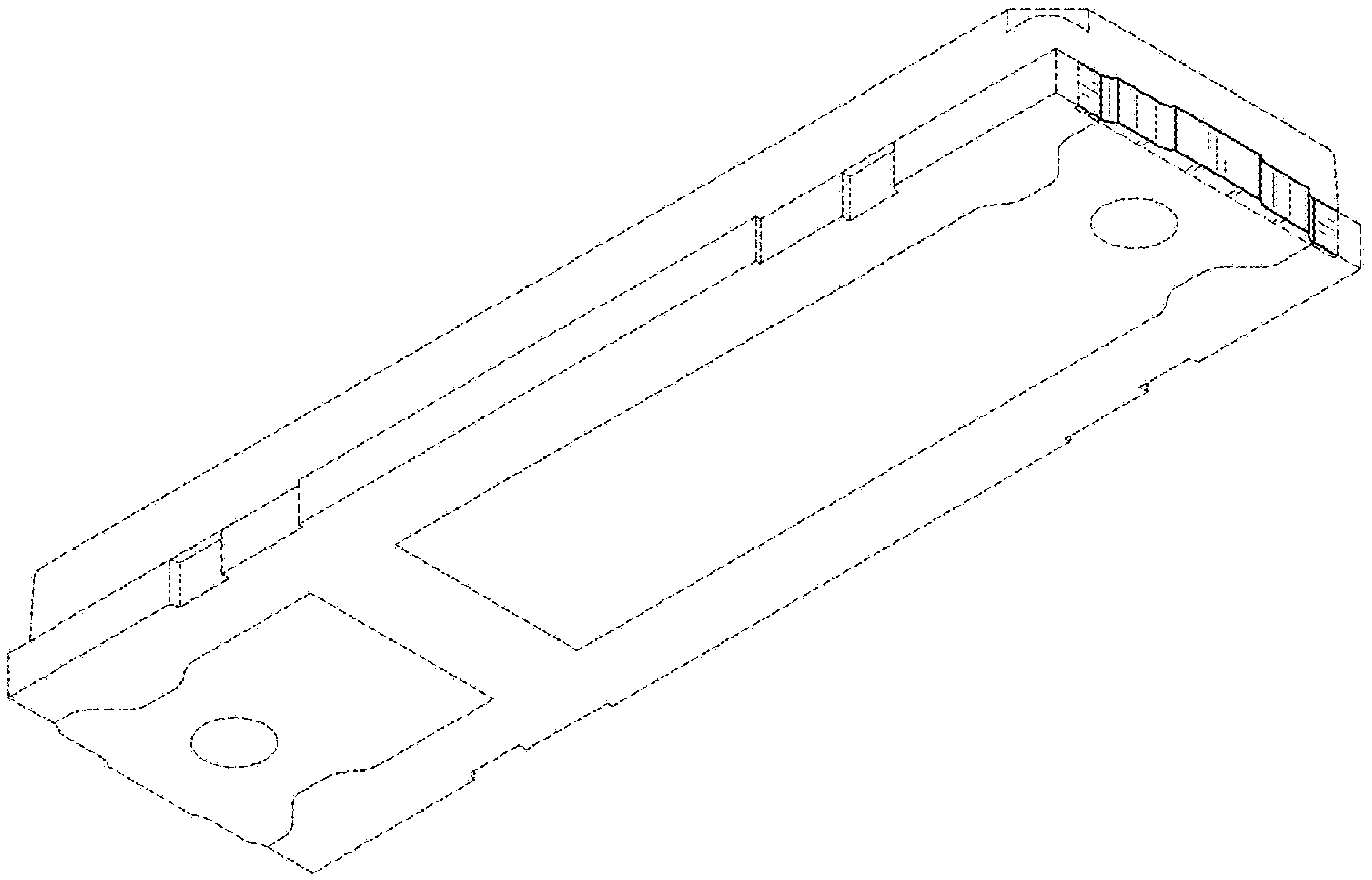

FIG. 2

FIG. 3

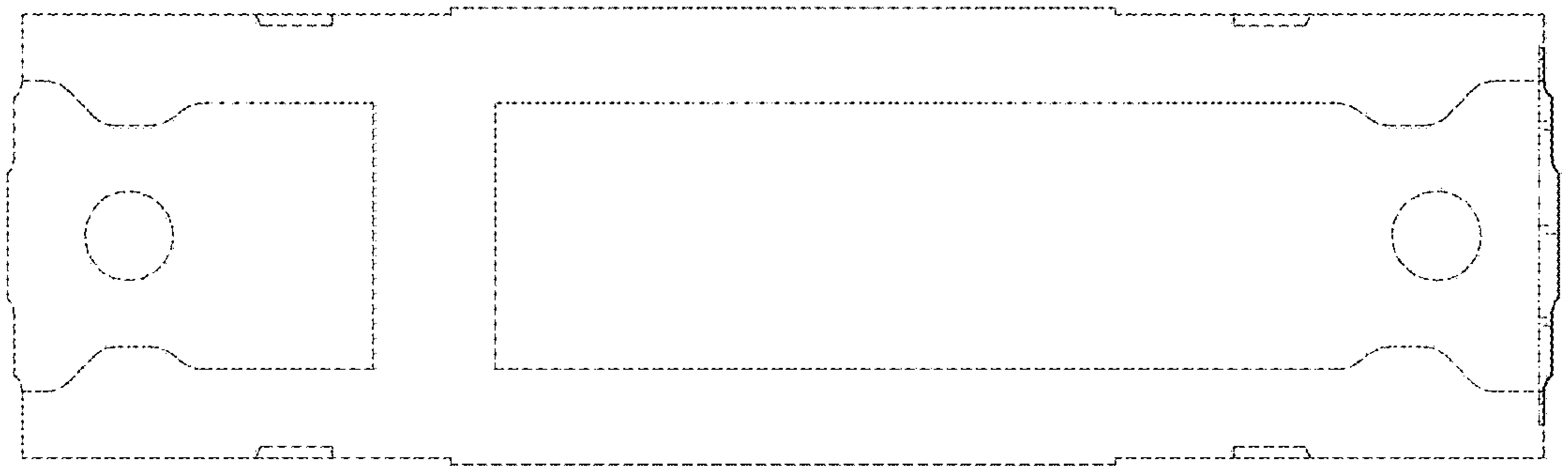

FIG. 4

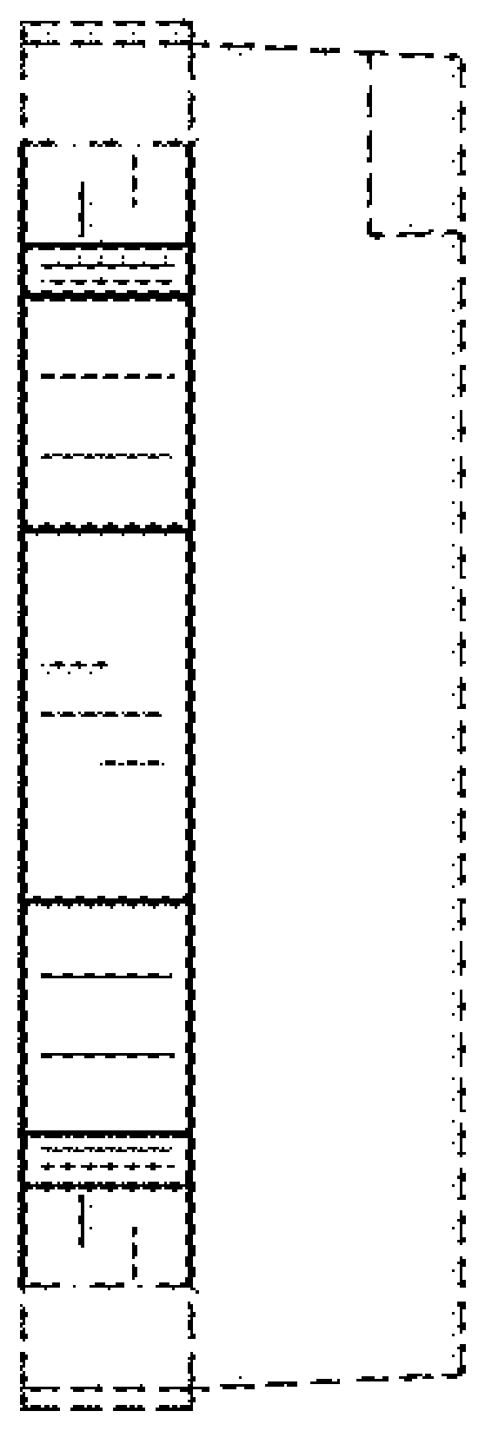

FIG. 5

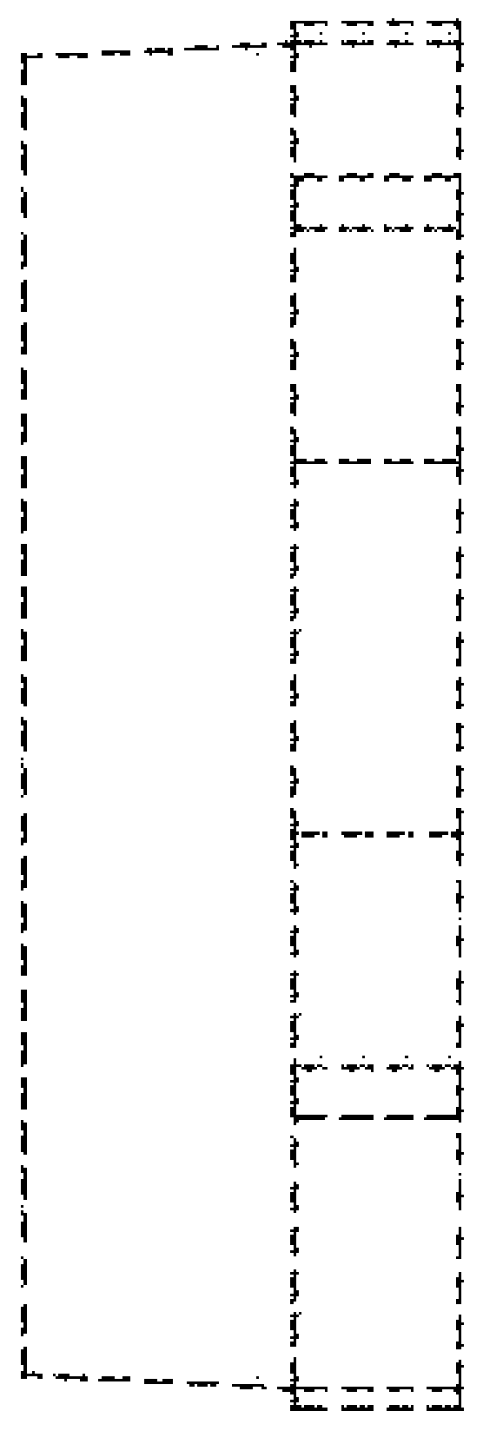

FIG. 6

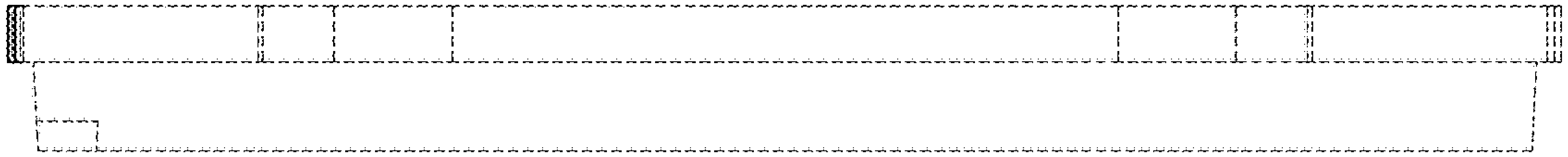

FIG. 7

FIG. 8

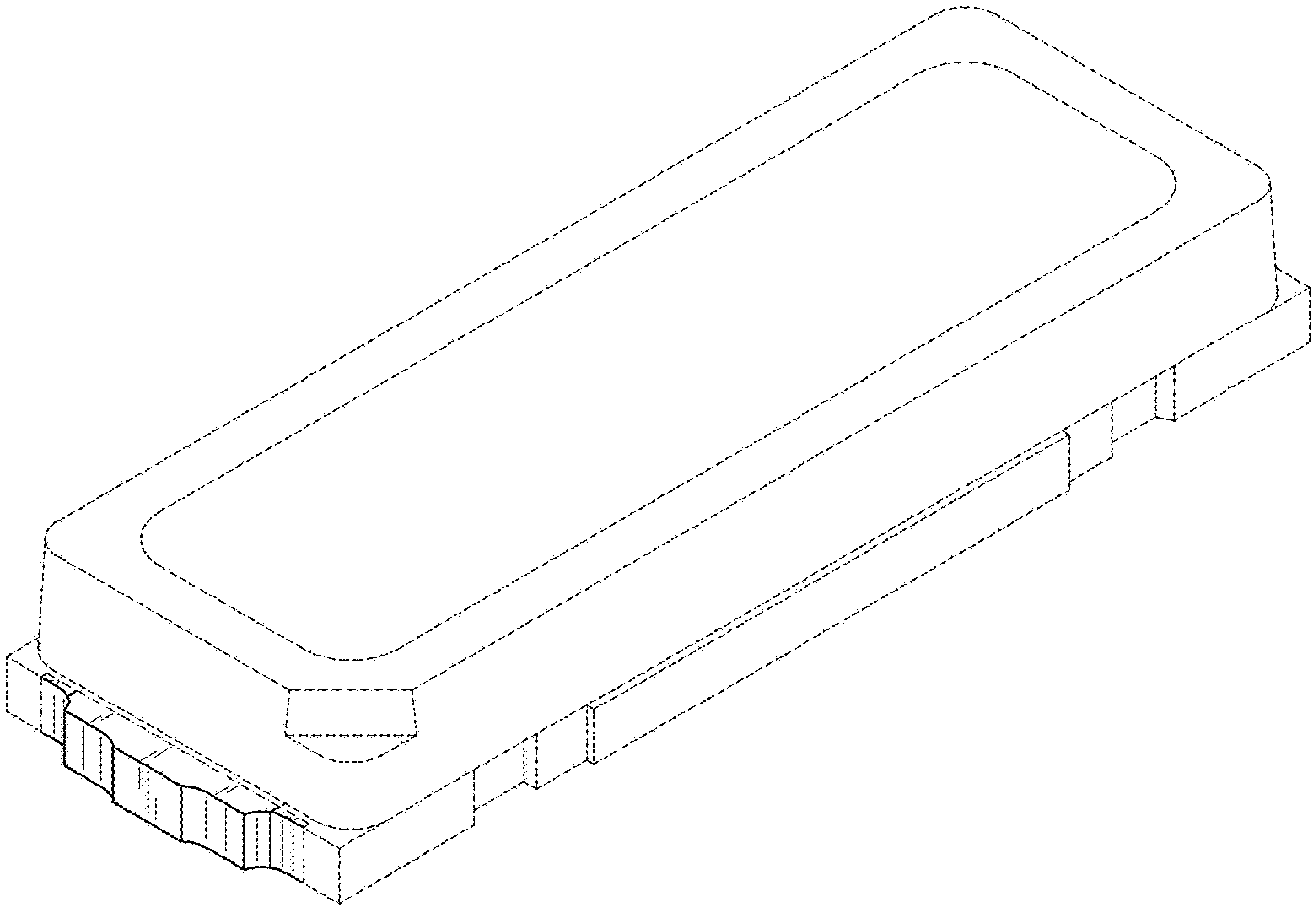

FIG. 9

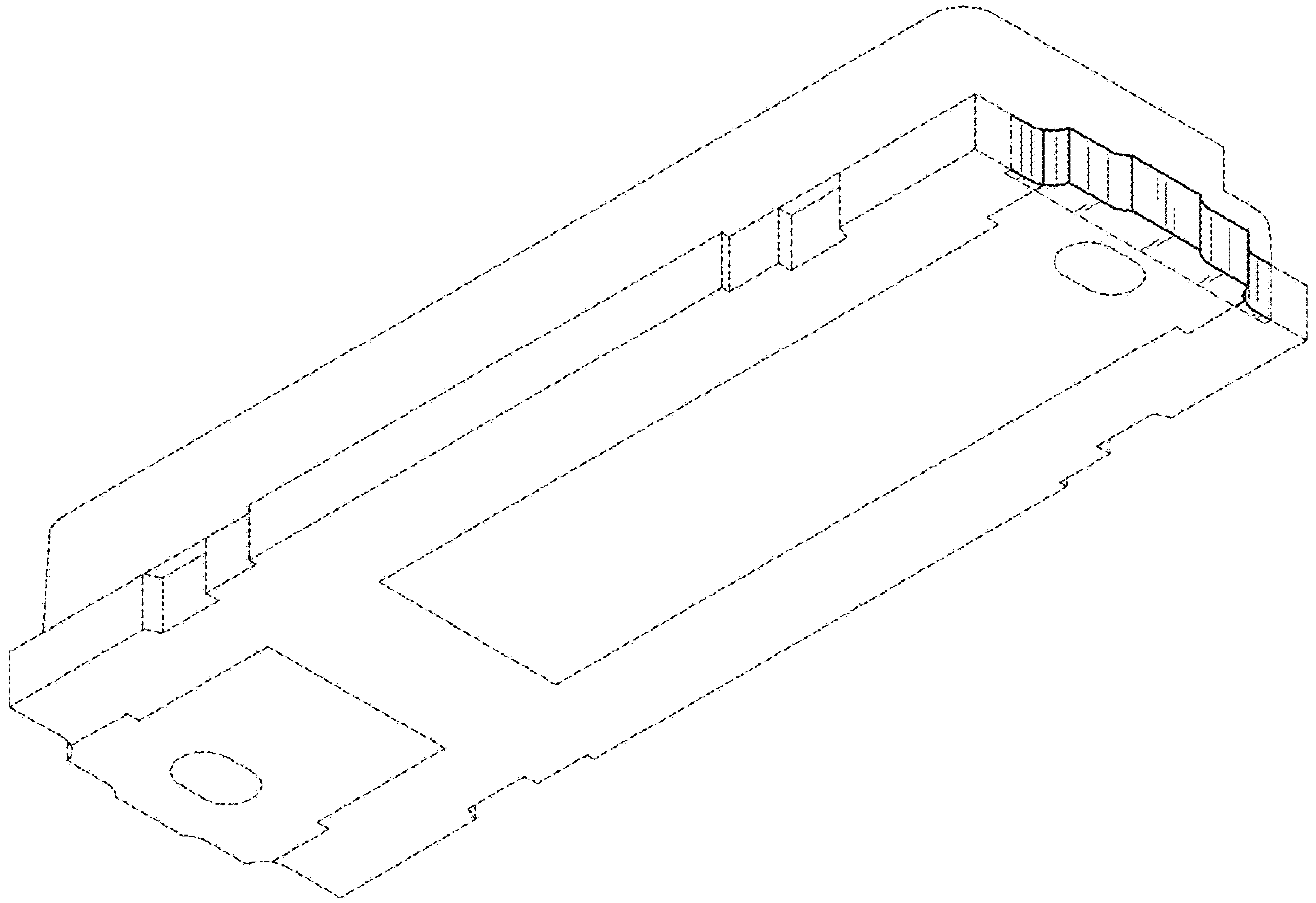

FIG. 10

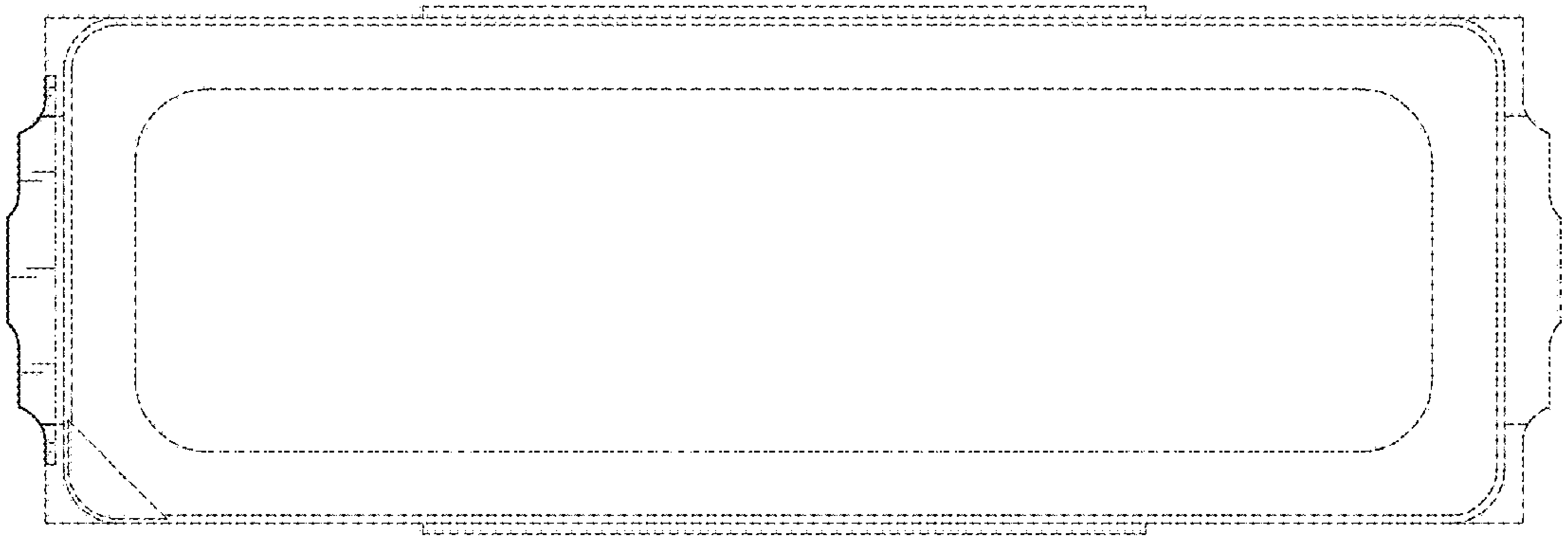

FIG. 11

FIG. 12

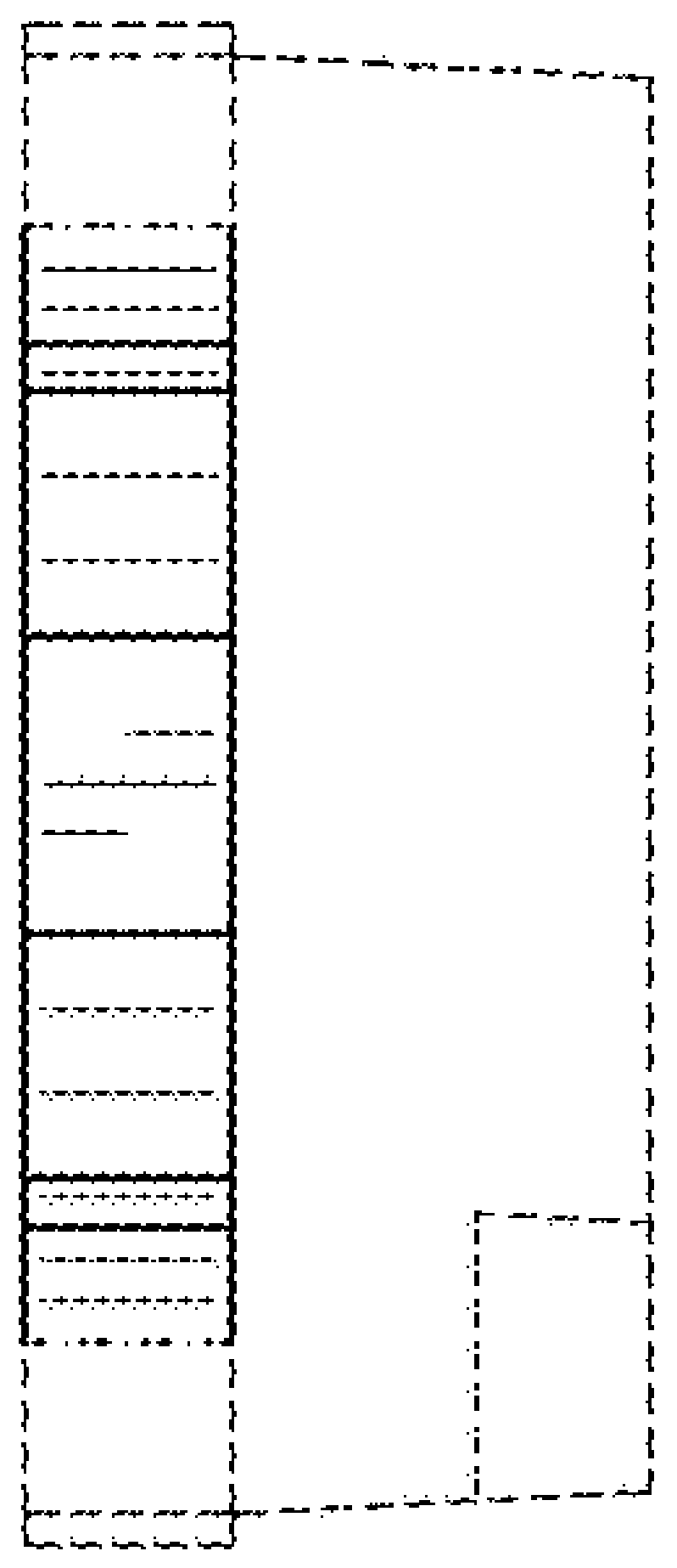

FIG. 13

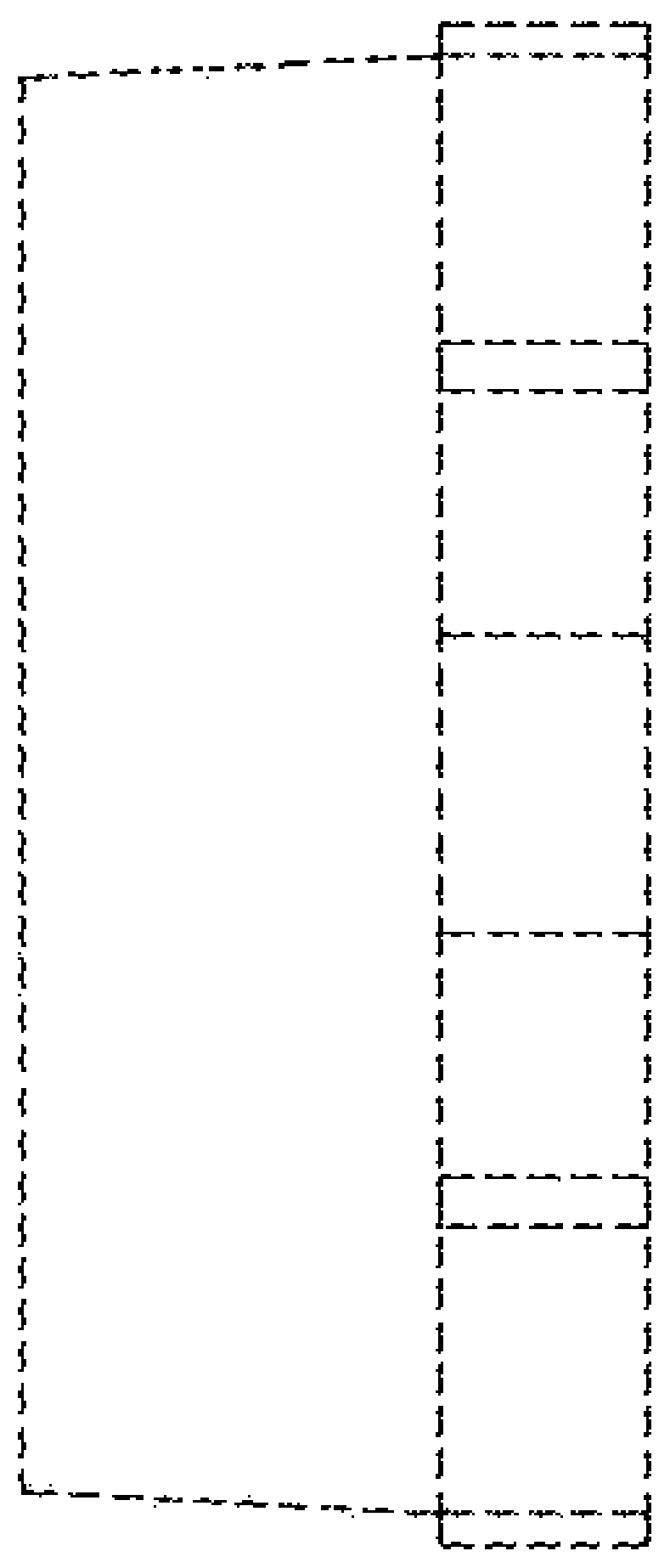

FIG. 14

FIG. 15

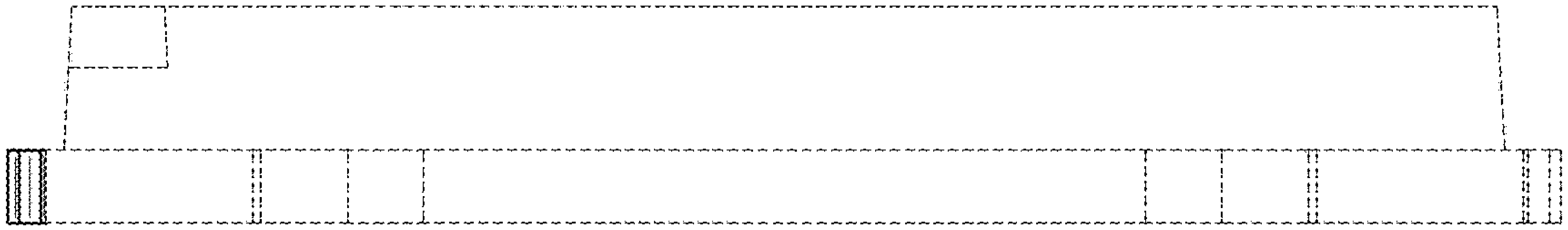

FIG. 16